



**PATENT APPLICATION**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

application of

Docket No: Q60187

Keiji SHIGESADA, et al.

Appln. No.: 09/622,360

Group Art Unit: 1722

Confirmation No.: 3575

Examiner: Emmanuel S. LUK

Filed: August 16, 2000

For: INJECTION MOLDING METHOD AND INJECTION MOLD

**RESPONSE UNDER 37 C.F.R. § 1.111**

**MAIL STOP AMENDMENT**

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated January 25, 2006, please consider the remarks as follows on the accompanying pages.

**TABLE OF CONTENTS**

REMARKS.....	2
--------------	---